IN THE CLAIMS

Please amend the claims as follows:

- 1. (original) A low-pass filter comprising a large and a small capacitor which are connected in parallel, the large capacitor being connected in series with a resistor, characterized in that the filter is embodied on the basis of a semiconductor substrate with a first surface, in which the small and the large capacitor are provided as vertical trench capacitors, the trenches extending to the first surface on which the resistor is provided.
- 2. (original) A low-pass filter as claimed in claim 1, characterized in that the semiconductor substrate further comprises a drift compensation part.
- 3. (original) A low-pass filter as claimed in claim 1, characterized in that one end of the filter is connected to ground.
- 4. (original) A low-pass filter as claimed in claim 1, characterized in that the small and the large capacitor are separated by a high-ohmic substrate zone with a resistance of at least 0.5 $k\Omega/cm$.

- 5. (original) A low-pass filter as claimed in claim 1, characterized in that the trench capacitors have a dielectric comprising silicon nitride.
- 6. (original) A low-pass filter as claimed in claim 1, characterized in that the resistor comprises a layer of polysilicon, in which layer the upper electrodes of the capacitors are defined as well.
- 7. (original) A low-pass filter as claimed in claim 1, characterized in that the semiconductor substrate further comprises diodes
- 8. (currently amended) An electronic device provided with a phase locked loop function comprising a comparator, a low-pass filter and a voltage controlled oscillator, the comparator and the oscillator being part of a single semiconductor device and the low-pass filter being embodied by a small and a large capacitor, characterized in that the low-pass filter according to any one of the claims 1 to $\frac{1}{2}$ to $\frac{1}{2}$ is present, which filter is assembled to the semiconductor device in a stacked die construction.

- 9. (original) An electronic device as claimed in claim 8, wherein the semiconductor device is provided with a first and an opposed second side, at which first side the low-pass filter is present and at which second side the semiconductor device can be coupled to a heat sink.
- 10. (currently amended) An electronic device as claimed in claim 8—or—9, characterized in that the low-pass filter has lateral dimensions which are at most equal to those of the semiconductor device.
- 11. (original) An electronic device as claimed in claim 8, wherein the phase locked loop is provided in an open loop architecture.